

### PD20015C

## RF power transistor, LdmoST family

#### **Features**

- Excellent thermal stability
- Common source configuration
- $\blacksquare$  P<sub>OUT</sub> = 15 W with 11 dB gain @ 2 GHz / 13.6 V
- BeO free package
- ESD protection
- In compliance with the 2002/95/EC european directive

### **Description**

The PD20015C is a common source N-channel, enhancement-mode lateral field-effect RF power transistor. It is designed for high gain, broadband commercial and industrial applications. It operates at 13.6 V in common source mode at frequencies of up to 2 GHz. PD20015C boasts the excellent gain, linearity and reliability of ST's latest LDMOS technology.

PD20015C's superior linearity performance makes it an ideal solution for mobile application.

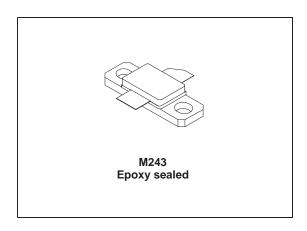
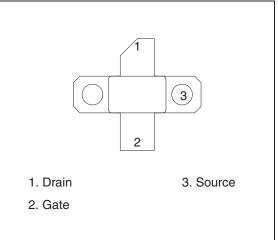


Figure 1. Pin connection



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PD20015C Electrical data

## 1 Electrical data

## 1.1 Maximum ratings

 $T_{CASE} = 25 \, ^{\circ}C$ 

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>(BR)DSS</sub>	Drain-source voltage	40	V
V <sub>GS</sub>	Gate-source voltage	- 0.5 to 15	V
I <sub>D</sub>	Drain current	7	Α
P <sub>DISS</sub>	Power dissipation (@ T <sub>C</sub> = 70 °C)	93	W
TJ	Max. operating junction temperature	200	°C
T <sub>STG</sub>	Storage temperature	-65 to +150	°C

### 1.2 Thermal data

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Junction - case thermal resistance	1.4	°C/W

Electrical characteristics PD20015C

## 2 Electrical characteristics

T<sub>CASE</sub> = +25 °C

### 2.1 Static

Table 4. Static

Symbol		Test conditions	Min.	Тур.	Max.	Unit	
I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 25 V		-		1	μΑ
I <sub>GSS</sub>	$V_{GS} = 5 V$	V <sub>DS</sub> = 0 V				1	μΑ
V <sub>GS(Q)</sub>	V <sub>DS</sub> = 10 V	I <sub>D</sub> = 350 mA		-	4.2		V
V <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1 A		-	270	310	mV
C <sub>ISS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 12.5 V	f = 1 MHz	-	49		pF
C <sub>OSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 12.5 V	f = 1 MHz	-	35		pF
C <sub>RSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 12.5 V	f = 1 MHz	1	1.0		pF

## 2.2 Dynamic

Table 5. Dynamic

Symbol	Test conditions	Min.	Тур.	Max.	Unit
P3dB	$V_{DD} = 13.6 \text{ V}, I_{DQ} = 350 \text{ mA}$ f = 2 GHz		23	-	W
G <sub>P</sub>	$V_{DD} = 13.6 \text{ V}, I_{DQ} = 350 \text{ mA}, P_{OUT} = 15 \text{ W}, f = 2 \text{ GHz}$	10	11	-	dB
h <sub>D</sub>	$V_{DD} = 13.6 \text{ V}, I_{DQ} = 350 \text{ mA}, P_{OUT} = P3dB, f = 2 \text{ GHz}$	45	53	-	%
Load mismatch	$V_{DD}$ = 15.5 V, $I_{DQ}$ = 350 mA, $P_{OUT}$ = 20 W, f = 2 GHz All phase angles	20:1		-	VSWR

## 2.3 ESD protection characteristics

Table 6. ESD protection characteristics

Test conditions	Class
Human body model	2
Machine model	M3

#### **Typical performance** 3

Capacitances vs drain voltage Figure 2.

DC output characteristics Figure 3.

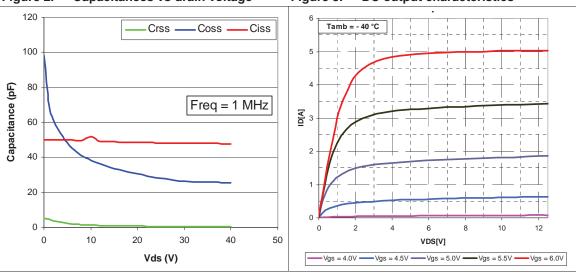
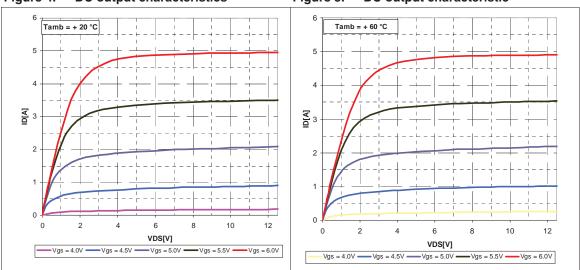


Figure 4. DC output characteristics

Figure 5. DC output characteristic



Typical performance PD20015C

Figure 6. Gain and efficiency vs Pout

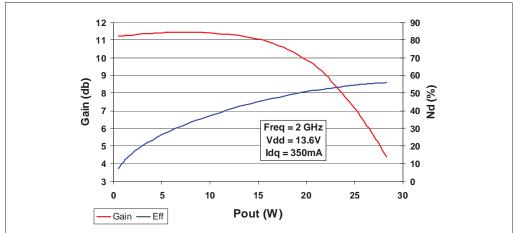
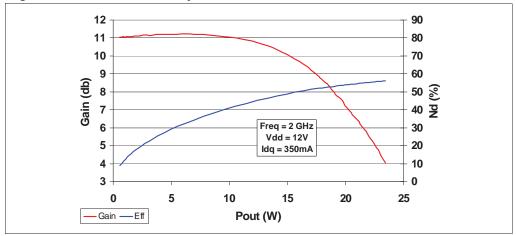


Figure 7. Gain and efficiency vs Pout



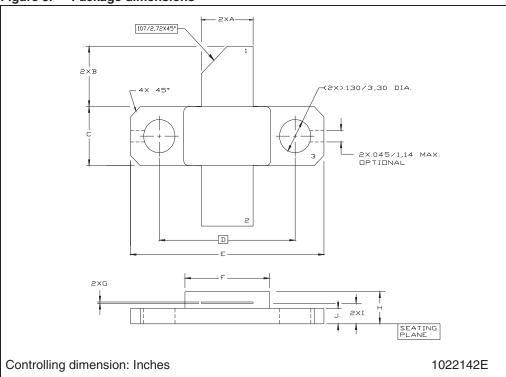
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

Table 7. M243 (0.230 x 0.360 2L N/HERM W/FLG) mechanical data

Dim.	mm.			mm. Inch		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	5.21		5.72	0.205		0.225
В	5.46		6.48	0.215		0.255
С	5.59		6.10	0.220		0.240
D		14.27			0.562	
Е	20.07		20.57	0.790		0.810
F	8.89		9.40	0.350		0.370
G	0.10		0.15	0.004		0.006
Н	3.18		4.45	0.125		0.175
I	1.83		2.24	0.072		0.088
J	1.27		1.78	0.050		0.070

Figure 8. Package dimensions



Revision history PD20015C

# 5 Revision history

Table 8. Document revision history

Date	Revision	Changes		
16-Nov-2007	1	Initial release.		
14-Apr-2009	2	Updated Table 4 on page 4		

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